Unit: mm

.5±0.1 (1.0)

2SD1199

Silicon NPN epitaxial planer type

For low-frequency amplification

Features

- High foward current transfer ratio h_{FE}. ٠
- Low collector to emitter saturation voltage V_{CE(sat)}.
- High emitter to base voltage V_{EBO}.
- Low noise voltage NV.
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

Absolute Maximum Ratings (Ta=25°C)

					- 1
Parameter	Symbol	Ratings	Unit		.5)
Collector to base voltage	V _{CBO}	50	V		
Collector to emitter voltage	V _{CEO}	40	v	1:Base	Ś
Emitter to base voltage	V _{EBO}	15	V	2:Collector	
Peak collector current	I _{CP}	100	mA	3:Emitter	
Collector current	Ic	50	mA		T
Collector power dissipation	P _C	400	mW	011 *150	
Junction temperature	Tj	150	°C	20 ret	
Storage temperature	T _{stg}	-55 ~ +150	°C		
			J		
Electrical Charac	teristics (Ta	=25°C)		250	
Parameter	Syr	mbol	Conditions	min	t
	I _{CBO}	V _{CB}	$20V, I_E = 0$		
Collector cutoff current		.(

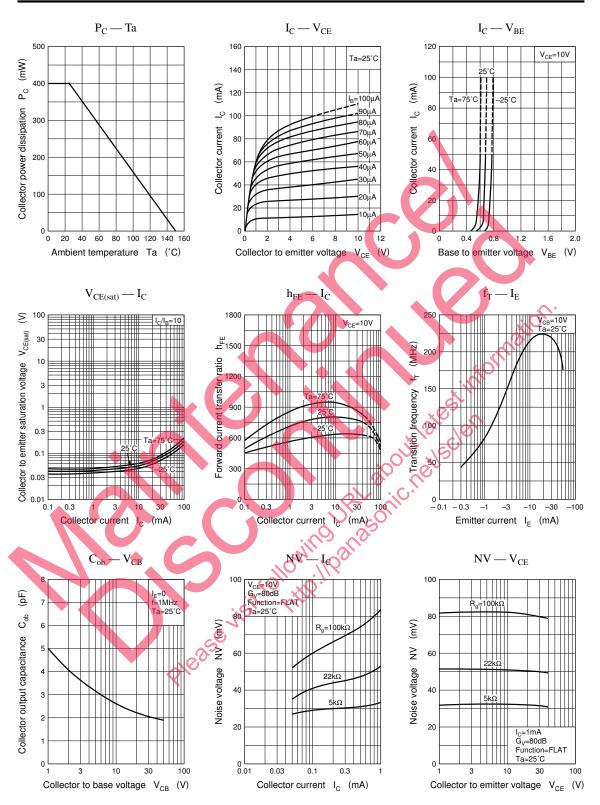


Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 20V, I_E = 0$			100	nA
	I _{CEO}	$V_{CE} = 20V_{c}I_{B} = 0$			1	μΑ
Collector to base voltage	V _{CBO}	$I_{\rm C} = 10 \mu A, I_{\rm E} = 0$	50			v
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 1 \mathrm{mA}, I_{\rm B} = 0$	40			v
Emitter to base voltage	VEBO	$I_E = 10 \mu A, I_C = 0$	15			v
Forward current transfer ratio	b _{FE}	$V_{CE} = 10V, I_C = 2mA$	400		2000	
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 1 {\rm mA}$		0.05	0.2	v
Transition frequency f _T		$V_{CB} = 10V, I_E = -2mA, f = 200MHz$		120		MHz
N	NV	$V_{CE} = 10V, I_C = 1mA, G_V = 80dB$		80		mV
Noise voltage		$R_g = 100k\Omega$, Function = FLAT	80			III V

*h_{FE} Rank classification

Rank	R	S	Т	
$h_{\rm FE}$	400 ~ 800	600 ~ 1200	1000 ~ 2000	



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